SPN200N04
N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN200N04 is the N-Channel enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. The SPN200N04 has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

APPLICATIONS

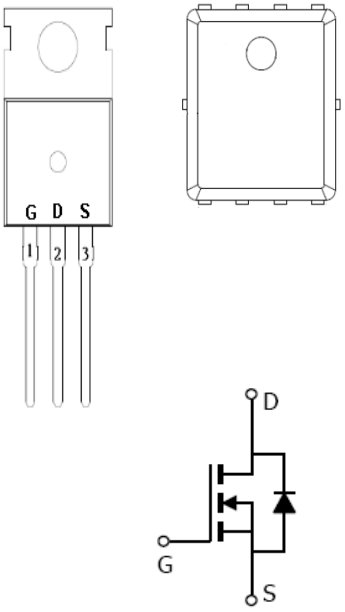
- High Frequency Synchronous Buck Converter
- DC/DC Power System
- Load Switch

FEATURES

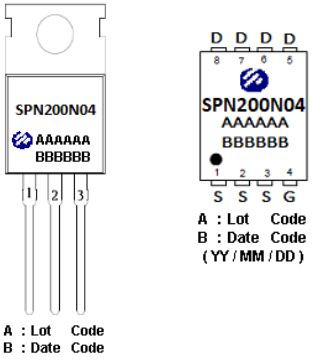
- 40V/200A,$R_{DS(ON)}$=1.6mΩ@V_{GS}=10V for PPAK5x6-8L
- 40V/200A,$R_{DS(ON)}$=2.3mΩ@V_{GS}=10V for TO-220
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- TO-220 and PPAK5x6-8L package design

PIN CONFIGURATION

TO-220 **PPAK5x6-8L**



PART MARKING



PIN DESCRIPTION

TO-220

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

PPAK5x6-8L

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN200N04T220TGB	TO-220	SPN200N04
SPN200N04DN8RGB	PPAK5x6-8L	SPN200N04

※ SPN200N04T220TGB : Tube ; Pb – Free ; Halogen - Free
※ SPN200N04DN8RGB : Tape Reel ; Pb – Free ; Halogen - Free

SPN200N04
N-Channel Enhancement Mode MOSFET

ABSOULTE MAXIMUM RATINGS

(T_A=25℃ Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		V_{DSS}	40	V
Gate –Source Voltage		V_{GSS}	±20	V
Continuous Drain Current (Silicon Limited)	T_C=25℃	I_D	200	A
	T_C=100℃		120	
Pulsed Drain Current		I_{DM}	400	A
Avalanche Current		I_{AS}	116	A
Single Pulse Avalanche Energy		EAS	673	mJ
Power Dissipation@ T_C=25℃	TO-220	P_D	104	W
	PPAK5x6-8L		83	
Operating Junction Temperature		T_J	-55~150	℃
Storage Temperature Range		T_{STG}	-55~150	℃
Thermal Resistance-Junction to Case	TO-220	$R_{\theta JC}$	1.2	℃/W
	PPAK5x6-8L		1.5	
Thermal Resistance-Junction to Ambient	TO-220	$R_{\theta JA}$	62	℃/W
	PPAK5x6-8L		55	

ELECTRICAL CHARACTERISTICS

(T_A=25℃ Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D=250uA	40			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250uA	2.0	2.8	4.0	V
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}=±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=32V,V_{GS}=0V			1	uA
		V_{DS}=32V,V_{GS}=0V,T_J=55℃			5	
On-State Drain Current	$I_{D(on)}$	V_{DS}≥5V,V_{GS}=10V			100	A
Drain-Source On-Resistance, TO220	$R_{DS(on)}$	V_{GS}=10V,I_D=20A		2.1	2.3	mΩ
Drain-Source On-Resistance, PPAK5x6-8L				1.4	1.6	
Gate Resistance	Rg	V_{DS}=V_{GS} =0V, f=1MHz		1.2		Ω
Diode Forward Voltage	V_{SD}	I_S=1A,V_{GS}=0V			1.2	V
Dynamic						
Total Gate Charge	Q_g	V_{DS}=20V,V_{GS}=10V I_D=20A		108		nC
Gate-Source Charge	Q_{gs}			25.4		
Gate-Drain Charge	Q_{gd}			26.8		
Input Capacitance	C_{iss}	V_{DS}=20V,V_{GS}=0V f=1MHz		6601		pF
Output Capacitance	C_{oss}			2073		
Reverse Transfer Capacitance	C_{rss}			248		
Turn-On Time	$t_{d(on)}$	V_{DD}=20V, I_D=20A,V_{GEN}=10V R_G=1.5Ω		20		nS
	t_r			145		
Turn-Off Time	$t_{d(off)}$			55		
	t_f			18		

TYPICAL CHARACTERISTICS

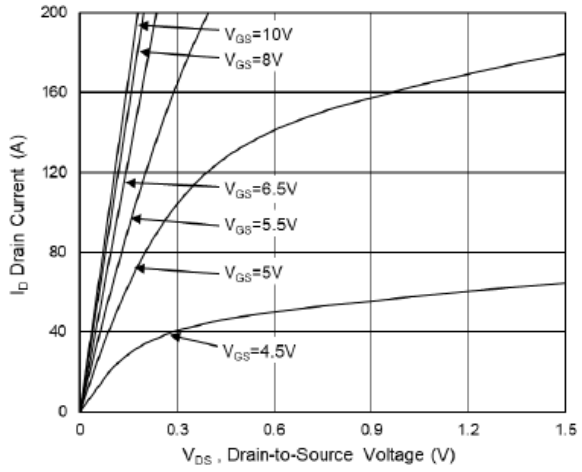


Fig.1 Typical Output Characteristics

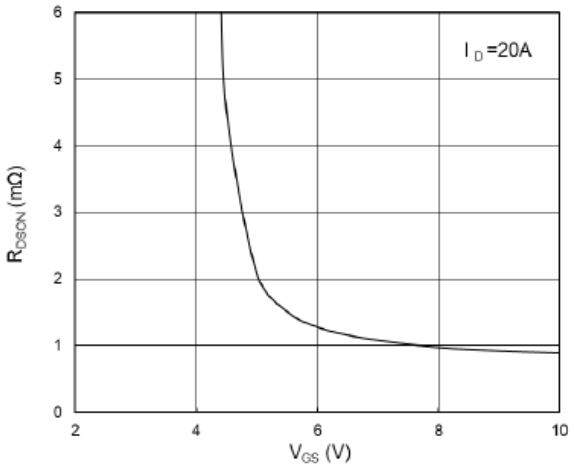


Fig.2 On-Resistance vs G-S Voltage

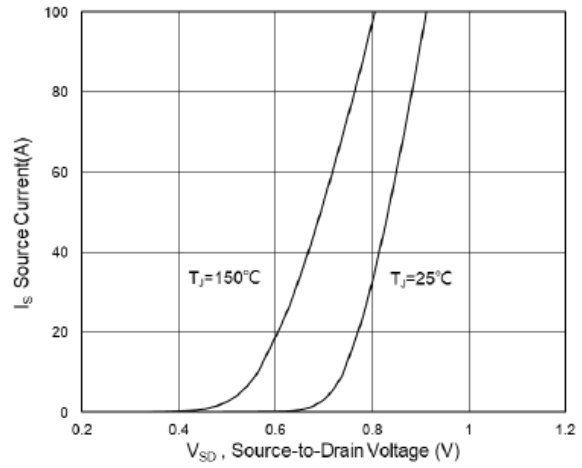


Fig.3 Source Drain Forward Characteristics

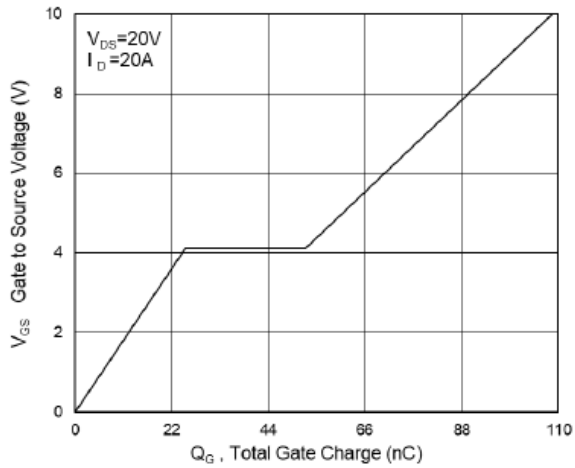


Fig.4 Gate-Charge Characteristics

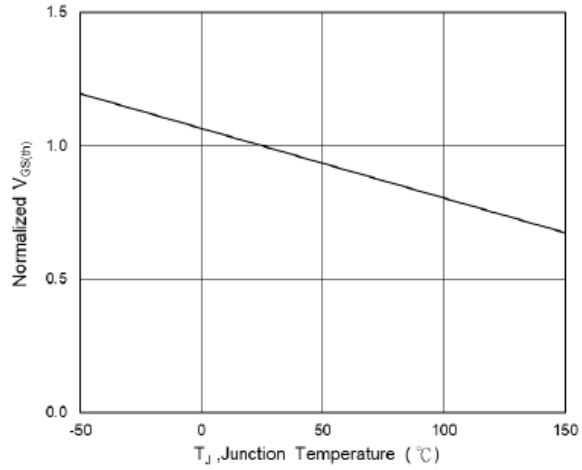


Fig.5 Normalized $V_{GS(th)}$ vs T_J

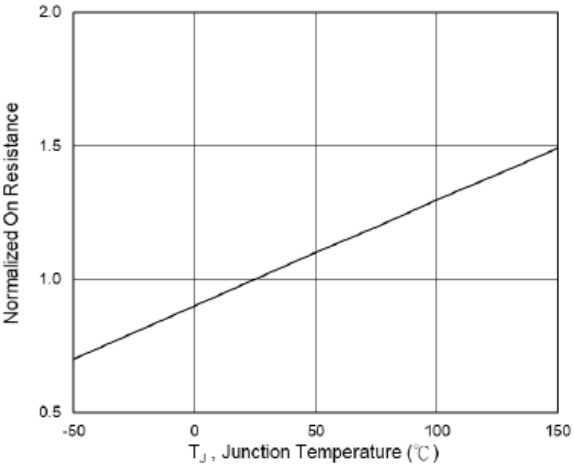


Fig.6 Normalized R_{DSON} vs T_J

TYPICAL CHARACTERISTICS

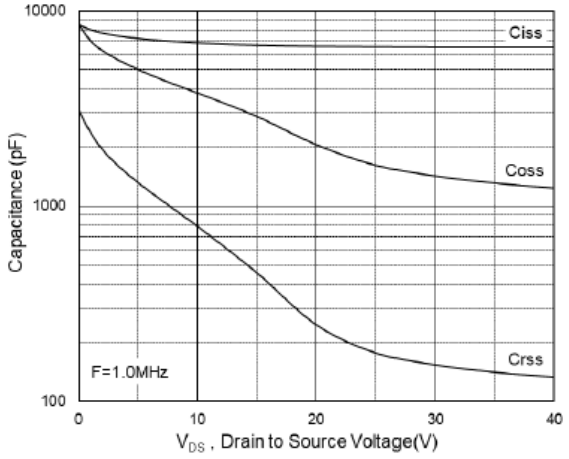


Fig.7 Capacitance

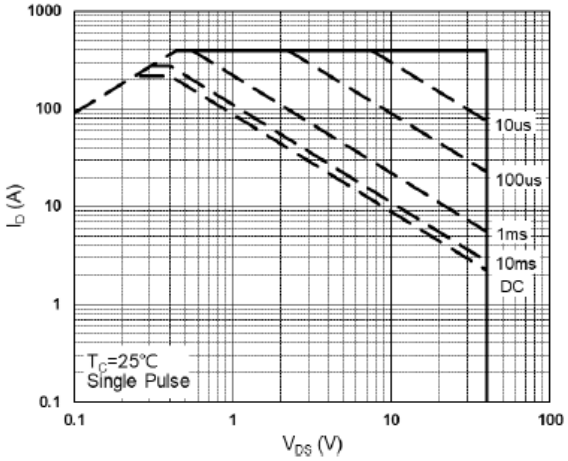


Fig.8 Safe Operating Area

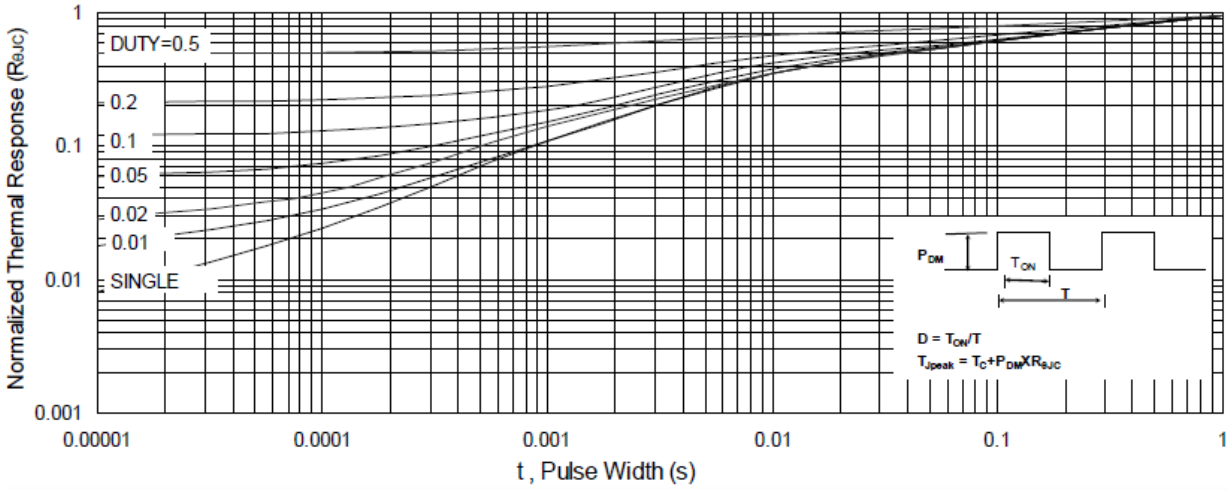


Fig.9 Normalized Maximum Transient Thermal Impedance

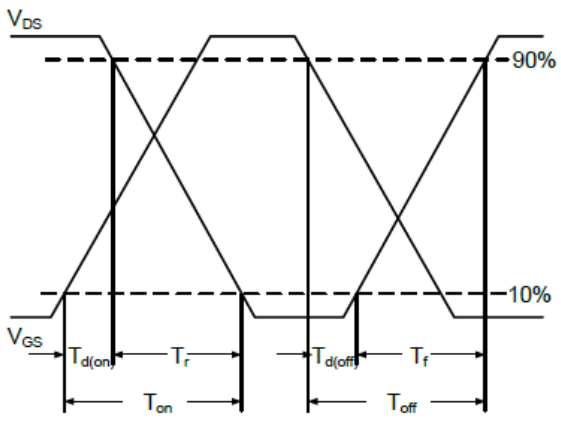


Fig.10 Switching Time Waveform

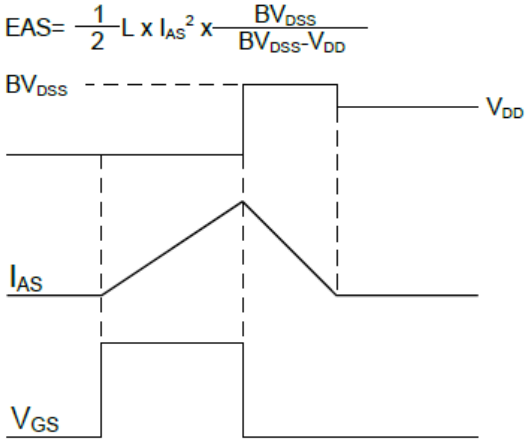


Fig.11 Unclamped Inductive Switching Waveform

SYNC Power Corporation
7F-2, No.3-1, Park Street
NanKang District (NKSP), Taipei, Taiwan 115
Phone: 886-2-2655-8178
Fax: 886-2-2655-8468
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